



DATA SHEET

CURRENT SENSOR - LOW TCR AUTOMOTIVE GRADE

PA series 5%, 1% sizes 2512 RoHS compliant & Halogen free

Product specification – August 22, 2014 V.0



yageo Phícomp

YAGEO Phicomp

Chip Resistor Surface Mount

SERIES 2512

<u>SCOPE</u>

This specification describes PA series current sensor - low TCR with lead-free terminations made by metal substrate.

APPLICATIONS

Consumer goods

- Computer
- Telecom / Datacom
- Industrial / Power supply
- Alternative Energy
- Car electronics

FEATURES

- Comply with AEC-Q200 standard
- Halogen-free Epoxy
- RoHS compliant
- Reduce environmentally hazardous wastes
- High component and equipment reliability
- Non-forbidden materials used in products/production
- Low resistances applied to current sensing

ORDERING INFORMATION - GLOBAL PART NUMBER

Global part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

GLOBAL PART NUMBER

ΡA

PA <u>XXXX X X X XX XXXX L</u>

(I) SIZE								
2512								
(2) TOLE	ANCE							
$F = \pm I$	%							
J = ±5%	/ >							
(3) PACK								
.,		IFE						
	bossed tap							
	bossed tap	ing reel		OF RESIS	TANCE		 	
K = Em (4) TEMPI	bossed tap	ing reel		OF RESIS	TANCE			
K = Em (4) TEMPI F = ±1	bossed tap RATURE	ing reel	CIENT	OF RESIS	TANCE		 	
K = Em (4) TEMPI F = ±1	bossed tap RATURE 10 ppm/°C 75 ppm/°C	ing reel		OF RESIS	TANCE			
K = Em (4) TEMPI $F = \pm I$ $H = \pm 2$ (5) TAPIN	bossed tap RATURE 10 ppm/°C 75 ppm/°C	ing reel				r		

I m Ω to 5 m Ω

(7) DEFAULT CODE

Letter L is the system default code for ordering only. ^(Note)

Resistance rule of global part number				
Resistance code rule	Example			
0RXXX (0.1 to 5 mΩ)	$0R001 = 1 m\Omega$			

ORDERING EXAMPLE

The ordering code of a PA2512 IW chip

resistor, TC100, value 0.003Ω with ±1% tolerance, supplied in 7-inch tape reel is: PA2512FKF070R003L

NOTE

I. All our RChip products are RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead-Free Process"



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<u>MARKING</u>

PA2512



CONSTRUCTION

The resistors are constructed using outstanding TCR level material, which makes Yageo PA resistors excellent for current sensing application in battery charger circuit & DC-DC converter.

The composition of the resistive material is adjusted to give the approximate required resistance and is covered with a protective coating. Marking is printed on the top side of the resistor.

Finally, the three external terminations (Cu / Ni / matte Tin) are added, as shown in Fig. 4.

Outlines





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DIMENSION

Table I For outlines, please refer to Fig. 4

TYPE	RESISTANCE RANGE	POWER RATING	L (mm)	W (mm)	H (mm)	l⊨(mm)	l2 (mm)
PA2512	lm Ω≦ R ≦ 4m Ω	- 2W -	6.35±0.25	3.18±0.25	0.63±0.25	2.21±0.25	2.21±0.25
	5m Ω	3W	6.35±0.25	3.18±0.25	0.63±0.25	1.19±0.25	1.19±0.25

Note:

I. For relevant physical dimensions, please refer to construction outlines.

2. Please contact with sales offices, distributors and representatives in your region before ordering.



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		Chip Re	sistor S	Surfac	e Mour	PA PA	SERIES	2512	- <u></u>
ELECT	RICAL	CHAR/	ACTERIS	<u>stics</u>					
Tabl	e 2								
SERIE	S SIZE	E	POWER	RATING	ì	TOLERANCE	RESISTAN	CE RANGE	
		07	7W	7T	47				OF RESISTANCE
DA	2512					±1%			Im Ω ± 275 ppm/°C
PA	2512	IW	2W	3W		±5%	lmΩ	≦ R≦5m Ω	2m Ω < R ≦ 5m Ω ± 100 ppm/°C

Note: Please contact with sales offices, distributors and representatives in your region before ordering.



V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$





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PACKING STYLE AND					
Table 3 Packing style and	I packaging quantity				
PACKING STYLE	REEL DIMENSION	PA2512			
Embossed taping reel (K)	7" (178 mm)	4,000			

EMBOSSED TAPE



SIZE	SYMBOL										Unit: mm
_	A ₀	Bo	W	Е	F	Po	Ρι	P ₂	ØD ₀	ØDı	т
PA2512	3.40±0.15	6.70±0.15	12.00±0.30	1.75±0.10	5.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.55±0.05	1.50±0.10	0.80±0.15



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REEL SPECIFICATION



- Table 5 Dimensions of reel specification for relevant chip resistors size

SIZE QUANTITY - PER REEL		REEL SIZE		SYMBOL				Unit: mm	
		8 mm TAPE WIDE	I 2 mm TAPE WIDE	А	Ν	С	D	Wı	W _{2 MAX.}
PA2512	4000		7" (Ø178 mm)	178.0±1.0	60.0+1/-0	13.50±0.5	21.0±0.8	13.6±0.5	16.5±0.5

LEADER/TRAILER TAPE SPECIFICATION





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FOOTPRINT AND SOLDERING PROFILES

For recommended soldering profiles, please refer to data sheet "Chip resistors mounting".

FOOTPRINT



Table 6 Footprint dimensions

	RESISTANCE					Unit: mm
SIZE	RANGE	POWER RATING	А	В	С	D
	$\textrm{Im}\Omega \leq \textrm{R} \leq 4\textrm{m}\Omega$	— IW, 2W, 3W	7.37	1.27	3.05	3.68
PA2512	5mΩ	- 100, 200, 300	7.40	3.18	2.11	3.68



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TESTS AND REQUIREMENTS

Table 8 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENT
Short time overload	IEC60115-14.13	5 times of rated power for 5 seconds at room temperature	±(0.5%+0.0005 Ω) No visible damage
High Temperature Exposure/ Endurance at	MIL-STD-202G-Method 108A	I,000 hours at maximum operating temperature depending on specification, unpowered	±(1.0%+0.0005 Ω)
Upper Category Temperature		No direct impingement of forced air to the parts Tolerances: I70±3°C	
Temperature Cycling	JESD22-A104C	1,000 cycles, -55/+125°C for 1 cycle per hour	±(0.5%+0.0005 Ω)
Moisture Resistance	MIL-STD-202G-Method 106F	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25°C / 65°C 95% R.H, without steps 7a & 7b, unpowered	±(0.5%+0.0005 Ω)
Biased Humidity	MIL-STD-202 Method 103	1,000 hours; 85°C / 85% RH	±(0.5%+0.0005 Ω)
-		10% of operating power	
Operational Life/ Endurance	MIL-STD-202G-Method 108A IEC 60115-1 4.25.1	1,000 hours at 125±3°C, de-rated voltage applied for 1.5 hours on, 0.5 hour off, still- air required	±(1.0%+0.0005 Ω)
		I,000 hours at 70±2°C applied RCWV	\pm (1.0%+0.0005 Ω)
		1.5 hours on, 0.5 hour off, still air required	
Resistance to Solvents	MIL-STD-202 Method 215	Immerse in isopropyl alcohol for 5 min with ultrasonic at room temperature	±(1.0%+0.0005 Ω)
Mechanical Shock	MIL-STD-202 Method 213	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen.	$\pm (0.5\% + 0.0005 \Omega)$
		Peak value: 1,500 g's	
		Duration: 0.5 ms	
		Velocity change: 15.4 ft/s	
		Waveform: Half sine	
Vibration	MIL-STD-202 Method 204	5 g's for 20 min., 12 cycles each of 3 orientations	±(0.5%+0.0005 Ω)
		Test from 10-2000 Hz.	
Resistance to	MIL-STD-202G-method 210F	Condition B, no pre-heat of samples	$\pm (0.5\% + 0.0005 \Omega)$
Soldering Heat		Leadfree solder, 260°C, 10 seconds immersion time	No visible damage
		Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	
Thermal Shock	MIL-STD-202 Method 107	-55/+150°C, Number of cycles is 300.	$\pm (0.5\% + 0.0005 \Omega)$
		Maximum transfer time is 20 seconds.	No visible damage
		Dwell time is 15 minutes. Air -Air	



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TEST	TEST METHOD	PROCEDURE	REQUIREMENT	
Electrostatic	AEC-Q200-002	Human Body Model, I pos + I neg.	±(1.0%+0.0005 Ω) No visible damage	
Discharge		Discharges 2512=2KV		
Solderability - Wetting	J-STD-002	(a) Method B, aging 4 hours at 155°C dry heat, dipping at 235±3°C for 5±0.5 seconds.	Well tinned (>95% covered) No visible damage	
		(b) Method B, steam aging 8 hours, dipping at 215±3°C for 5±0.5 seconds.		
		(c) Method D, steam aging 8 hours, dipping at 260±3 °C for 7±0.5 seconds.		
Flammability	UL94	Try to inflame a specimen by a needle flame	No ignition of specimen; V-0	
Board Flex / Bending	AEC-Q200-005	Chips mounted on a 90mm glass epoxy resin PCB (FR4), Bending for 2512=2 mm	±(1.0%+0.0005 Ω)	
		Holding time: Min.60 seconds		
Terminal Strength (SMD)	AEC-Q200-006	Applied a 17.7N (1.8Kg) for 60±1 seconds.	±(1.0%+0.0005 Ω) No visible damage	
Flame Retardance	AEC-Q200-001	Apply voltage from 9V to 32V to increase the surface temp to 350°C	No flame, no explosion	
Temperature Coefficient of Resistance (T.C.R.)	IEC 60115-1 4.8	At +25/–55℃ and +25/+125℃	Refer to table 2	
		Formula:		
		$T.C.R = \frac{\mathbf{R}_2 - \mathbf{R}_1}{\mathbf{RI}(\mathbf{t}_2 - \mathbf{t}_i)} \times I0^6(\text{ppm/°C})$		
		Where		
		tI=+25°C or specified room temperature		
		t2=–55°C or +125°C test temperature		
		RI=resistance at reference temperature in ohms		
		R2=resistance at test temperature in ohms		
Flower-of-Sulfur (FOS)	Modified ASTM B809-95	Sulfur 105°C, 750 hours, unpowered.	±(1.0%+0.0005 Ω)	



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REVISION	<u>HISTORY</u>					
REVISION	DATE	CHANGE NOTIFICATION	DESCR	RIPTION		
Version 0	Aug. 22, 2014	-	- New datasheet for automotive grade current sensor -PA series.			

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